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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chao-Ta Huang	04/27/2012
Yu-Wen Hsu	04/26/2012
Chin-Fu Kuo	04/26/2012

RECEIVING PARTY DATA

Name:	Industrial Technology Research Institute	
Street Address:	No. 195, Sec. 4, Chung Hsing Rd., Chutung,	
City:	Hsinchu	
State/Country:	TAIWAN	
Postal Code:	31040	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13459271

CORRESPONDENCE DATA

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Correspondent Name: JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE

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ATTORNEY DOCKET NUMBER:	40512-US-PA
NAME OF SUBMITTER:	Belinda Lee

Total Attachments: 2

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> PATENT REEL: 028139 FRAME: 0433

ASSIGNMENT

WHEREAS.

1. Chao-Ta Huang

2. Yu-Wen Hsu

3. Chin-Fu Kuo

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: MICROELECTROMECHANICAL SYSTEM DEVICE WITH ELECTRICAL INTERCONNECTIONS AND METHOD FOR FABRICATING THE SAME

[] Filed:

Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, Industrial Technology Research Institute

of No. 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu 31040, Taiwan, R. O. C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

PATENT REEL: 028139 FRAME: 0434 P27000076US 40512-US-PA

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Chao-fa Muomf

Date: 64-27-20/2

Sole or First Joint Inventor: Chao-Ta Huang //

Second Joint Inventor (if any): Yu-Wen Hsu

Date: 04/26/2012

Signature: Chan tu Kuo

Third Joint Inventor (if any): Chin-Fu Kuo

Date: 04/26/2012